

# IS41LV16105D

## 1Mx16

## 16Mb DRAM WITH FAST PAGE MODE

MARCH 2020

### FEATURES

- TTL compatible inputs and outputs; tristate I/O
- Refresh Interval:  
— 1,024 cycles/16 ms
- Refresh Mode:  
—  $\overline{\text{RAS}}$ -Only,  $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$  (CBR), and Hidden
- JEDEC standard pinout
- Single power supply:  
—  $3.3\text{V} \pm 10\%$
- Byte Write and Byte Read operation via two  $\overline{\text{CAS}}$
- Industrial Temperature Range  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$

### DESCRIPTION

The ISSI IS41LV16105D is a 1,048,576 x 16-bit high-performance CMOS Dynamic Random Access Memories. Fast Page Mode allows 1,024 random accesses within a single row with access cycle time as short as 20 ns per 16-bit word. It is asynchronous, as it does not require a clock signal input to synchronize commands and I/O.

These features make the IS41LV16105D ideally suited for high-bandwidth graphics, digital signal processing, high-performance computing systems, and peripheral applications that run without a clock to synchronize with the DRAM.

The IS41LV16105D is packaged in a 400-mil 50/44-pin TSOP (Type II).

### KEY TIMING PARAMETERS

| Parameter                                                    | -50 | Unit |
|--------------------------------------------------------------|-----|------|
| Max. $\overline{\text{RAS}}$ Access Time (t <sub>RAC</sub> ) | 50  | ns   |
| Max. $\overline{\text{CAS}}$ Access Time (t <sub>CAC</sub> ) | 13  | ns   |
| Max. Column Address Access Time (t <sub>AA</sub> )           | 25  | ns   |
| Min. Fast Page Mode Cycle Time (t <sub>PC</sub> )            | 20  | ns   |
| Min. Read/Write Cycle Time (t <sub>RC</sub> )                | 84  | ns   |

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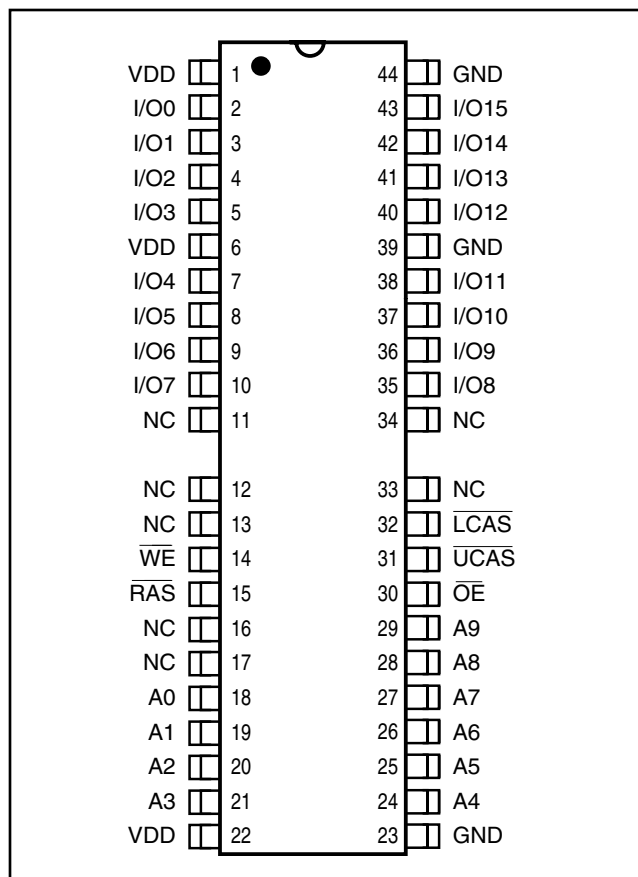
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# IS41LV16105D

## PIN CONFIGURATIONS

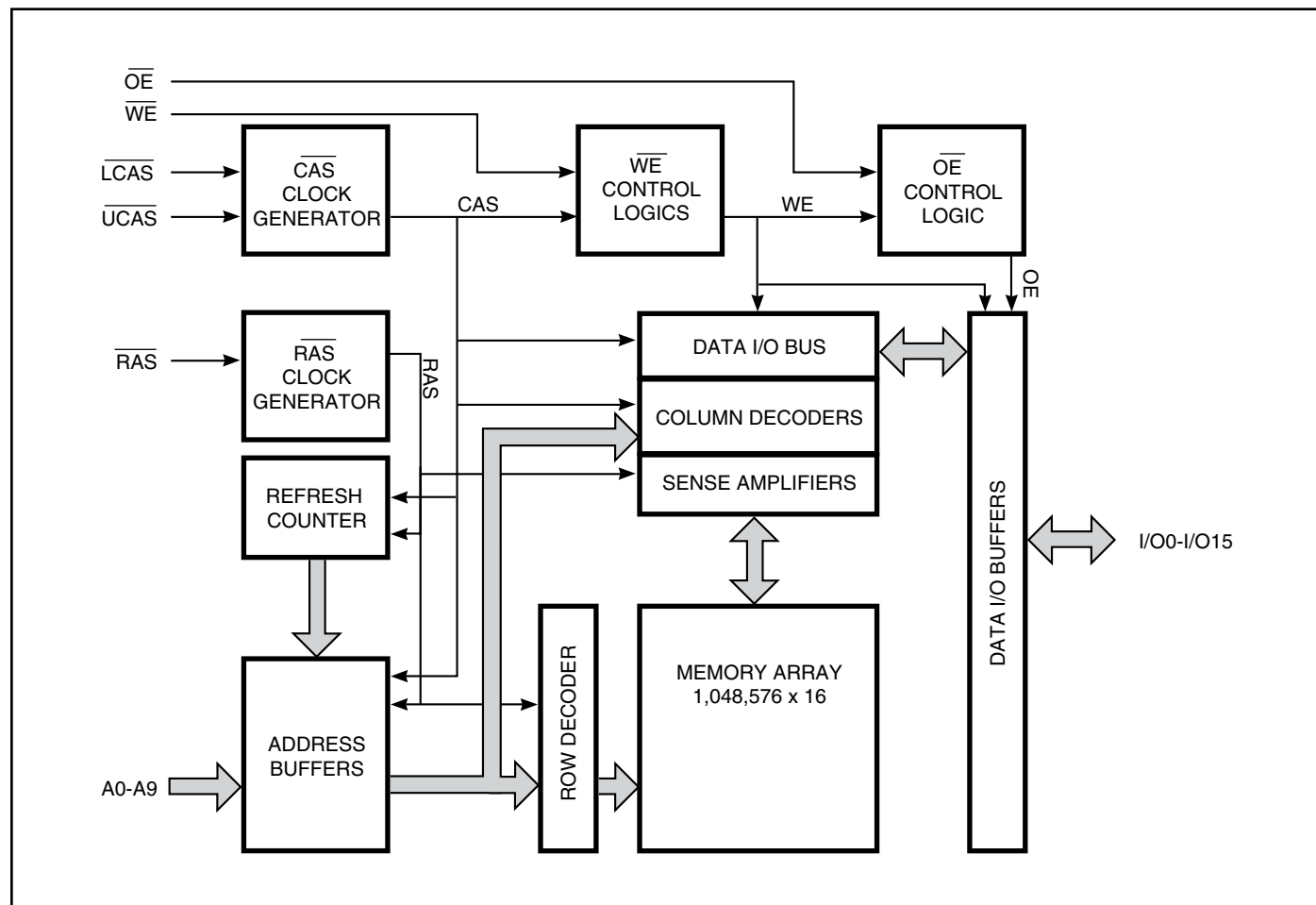
### 44(50)-Pin TSOP (Type II)



## PIN DESCRIPTIONS

|                   |                             |
|-------------------|-----------------------------|
| A0-A9             | Address Inputs              |
| I/O0-15           | Data Inputs/Outputs         |
| $\overline{WE}$   | Write Enable                |
| $\overline{OE}$   | Output Enable               |
| $\overline{RAS}$  | Row Address Strobe          |
| $\overline{UCAS}$ | Upper Column Address Strobe |
| $\overline{LCAS}$ | Lower Column Address Strobe |
| VDD               | Power                       |
| GND               | Ground                      |
| NC                | No Connection               |

## FUNCTIONAL BLOCK DIAGRAM



**TRUTH TABLE<sup>(5)</sup>**

| Function                              | $\overline{\text{RAS}}$ | $\overline{\text{LCAS}}$ | $\overline{\text{UCAS}}$ | $\overline{\text{WE}}$ | $\overline{\text{OE}}$ | Address tr/tc | I/O                                    |
|---------------------------------------|-------------------------|--------------------------|--------------------------|------------------------|------------------------|---------------|----------------------------------------|
| Standby                               | H                       | X                        | X                        | X                      | X                      | X             | High-Z                                 |
| Read: Word                            | L                       | L                        | L                        | H                      | L                      | ROW/COL       | DOUT                                   |
| Read: Lower Byte                      | L                       | L                        | H                        | H                      | L                      | ROW/COL       | Lower Byte, DOUT<br>Upper Byte, High-Z |
| Read: Upper Byte                      | L                       | H                        | L                        | H                      | L                      | ROW/COL       | Lower Byte, High-Z<br>Upper Byte, DOUT |
| Write: Word (Early Write)             | L                       | L                        | L                        | L                      | X                      | ROW/COL       | DIN                                    |
| Write: Lower Byte (Early Write)       | L                       | L                        | H                        | L                      | X                      | ROW/COL       | Lower Byte, DIN<br>Upper Byte, High-Z  |
| Write: Upper Byte (Early Write)       | L                       | H                        | L                        | L                      | X                      | ROW/COL       | Lower Byte, High-Z<br>Upper Byte, DIN  |
| Read-Write <sup>(1,2)</sup>           | L                       | L                        | L                        | H→L                    | L→H                    | ROW/COL       | DOUT, DIN                              |
| Hidden Refresh                        | L→H→L                   | L                        | L                        | H                      | L                      | ROW/COL       | DOUT                                   |
|                                       |                         | L                        | L                        | L                      | X                      | ROW/COL       | DOUT                                   |
| $\overline{\text{RAS}}$ -Only Refresh | L                       | H                        | H                        | X                      | X                      | ROW/NA        | High-Z                                 |
| CBR Refresh <sup>(4)</sup>            | H→L                     | L                        | L                        | H                      | X                      | X             | High-Z                                 |

**Notes:**

1. These WRITE cycles may also be BYTE WRITE cycles (either  $\overline{\text{LCAS}}$  or  $\overline{\text{UCAS}}$  active).
2. These READ cycles may also be BYTE READ cycles (either  $\overline{\text{LCAS}}$  or  $\overline{\text{UCAS}}$  active).
3. EARLY WRITE only.
4. At least one of the two  $\overline{\text{CAS}}$  signals must be active ( $\overline{\text{LCAS}}$  or  $\overline{\text{UCAS}}$ ).
5. Commands valid only after initialization.

## Functional Description

The IS41LV16105D is a CMOS DRAM optimized for high-speed bandwidth, low power applications. During READ or WRITE cycles, each bit is uniquely addressed through the 16 address bits. These are entered ten bits (A0-A9) at a time. The row address is latched by the Row Address Strobe ( $\overline{\text{RAS}}$ ). The column address is latched by the Column Address Strobe ( $\overline{\text{CAS}}$ ).  $\overline{\text{RAS}}$  is used to latch the first nine bits and  $\overline{\text{CAS}}$  is used the latter nine bits.

The IS41LV16105D has two  $\overline{\text{CAS}}$  controls,  $\overline{\text{LCAS}}$  and  $\overline{\text{UCAS}}$ . The  $\overline{\text{LCAS}}$  and  $\overline{\text{UCAS}}$  inputs internally generates a  $\overline{\text{CAS}}$  signal functioning in an identical manner to the single  $\overline{\text{CAS}}$  input on the other 1M x 16 DRAMs. The key difference is that each  $\overline{\text{CAS}}$  controls its corresponding I/O tristate logic (in conjunction with  $\overline{\text{OE}}$  and  $\overline{\text{WE}}$  and  $\overline{\text{RAS}}$ ).  $\overline{\text{LCAS}}$  controls I/O0 through I/O7 and  $\overline{\text{UCAS}}$  controls I/O8 through I/O15.

The IS41LV16105D  $\overline{\text{CAS}}$  function is determined by the first  $\overline{\text{CAS}}$  ( $\overline{\text{LCAS}}$  or  $\overline{\text{UCAS}}$ ) transitioning LOW and the last transitioning back HIGH. The two  $\overline{\text{CAS}}$  controls give the IS41LV16105D both BYTE READ and BYTE WRITE cycle capabilities.

## Memory Cycle

A memory cycle is initiated by bring  $\overline{\text{RAS}}$  LOW and it is terminated by returning both  $\overline{\text{RAS}}$  and  $\overline{\text{CAS}}$  HIGH. To ensure proper device operation and data integrity any memory cycle, once initiated, must not be ended or aborted before the minimum  $t_{\text{RAS}}$  time has expired. A new cycle must not be initiated until the minimum precharge time  $t_{\text{RP}}$ ,  $t_{\text{CP}}$  has elapsed.

## Read Cycle

A read cycle is initiated by the falling edge of  $\overline{\text{CAS}}$  or  $\overline{\text{OE}}$ , whichever occurs last, while holding  $\overline{\text{WE}}$  HIGH. The column address must be held for a minimum time specified by  $t_{\text{AR}}$ . Data Out becomes valid only when  $t_{\text{RAC}}$ ,  $t_{\text{AA}}$ ,  $t_{\text{CAC}}$  and  $t_{\text{OEA}}$  are all satisfied. As a result, the access time is dependent on the timing relationships between these parameters.

## Write Cycle

A write cycle is initiated by the falling edge of  $\overline{\text{CAS}}$  and  $\overline{\text{WE}}$ , whichever occurs last. The input data must be valid at or before the falling edge of  $\overline{\text{CAS}}$  or  $\overline{\text{WE}}$ , whichever occurs last.

## Refresh Cycle

To retain data, 1,024 refresh cycles are required in each 16 ms period. There are two ways to refresh the memory.

1. By clocking each of the 1,024 row addresses (A0 through A9) with  $\overline{\text{RAS}}$  at least once every  $t_{\text{REF max}}$ . Any read, write, read-modify-write or  $\overline{\text{RAS}}$ -only cycle refreshes the addressed row.
2. Using a  $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$  refresh cycle.  $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$  refresh is activated by the falling edge of  $\overline{\text{RAS}}$ , while holding  $\overline{\text{CAS}}$  LOW. In  $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$  refresh cycle, an internal 9-bit counter provides the row addresses and the external address inputs are ignored.

$\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$  is a refresh-only mode and no data access or device selection is allowed. Thus, the output remains in the High-Z state during the cycle.

## Power-On

During Power-On,  $\overline{\text{RAS}}$ ,  $\overline{\text{UCAS}}$ ,  $\overline{\text{LCAS}}$ , and  $\overline{\text{WE}}$  must all track with  $V_{\text{DD}}$  (HIGH) to avoid current surges, and allow initialization to continue. An initial pause of 200  $\mu\text{s}$  is required followed by a minimum of eight initialization cycles (any combination of cycles containing a  $\overline{\text{RAS}}$  signal).

# IS41LV16105D

## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

| Symbol           | Parameters                         | Rating       | Unit |
|------------------|------------------------------------|--------------|------|
| V <sub>T</sub>   | Voltage on Any Pin Relative to GND | −0.5 to +4.6 | V    |
| V <sub>DD</sub>  | Supply Voltage                     | −0.5 to +4.6 | V    |
| I <sub>OUT</sub> | Output Current                     | 50           | mA   |
| P <sub>D</sub>   | Power Dissipation                  | 1            | W    |
| T <sub>A</sub>   | Industrial Temperature             | −40 to +85   | °C   |
| T <sub>STG</sub> | Storage Temperature                | −55 to +125  | °C   |

### Note:

- Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

## RECOMMENDED OPERATING CONDITIONS (Voltages are referenced to GND.)

| Symbol          | Parameter                 | Test Condition                                                                       | Min. | Typ. | Max.                  | Unit |
|-----------------|---------------------------|--------------------------------------------------------------------------------------|------|------|-----------------------|------|
| V <sub>DD</sub> | Supply Voltage            |                                                                                      | 3.0  | 3.3  | 3.6                   | V    |
| V <sub>IH</sub> | Input High Voltage        |                                                                                      | 2.0  | —    | V <sub>DD</sub> + 0.3 | V    |
| V <sub>IL</sub> | Input Low Voltage         |                                                                                      | −0.3 | —    | 0.8                   | V    |
| I <sub>IL</sub> | Input Leakage Current     | Any input 0V ≤ V <sub>IN</sub> ≤ V <sub>DD</sub><br>Other inputs not under test = 0V | −5   |      | 5                     | μA   |
| I <sub>IO</sub> | Output Leakage Current    | Output is disabled (Hi-Z)<br>0V ≤ V <sub>OUT</sub> ≤ V <sub>DD</sub>                 | −5   |      | 5                     | μA   |
| V <sub>OH</sub> | Output High Voltage Level | I <sub>OH</sub> = −2.0 mA                                                            | 2.4  |      | —                     | V    |
| V <sub>OL</sub> | Output Low Voltage Level  | I <sub>OL</sub> = 2.0 mA                                                             | —    |      | 0.4                   | V    |

## CAPACITANCE<sup>(1,2)</sup>

| Symbol           | Parameter                                                                                                                                          | Max. | Unit |
|------------------|----------------------------------------------------------------------------------------------------------------------------------------------------|------|------|
| C <sub>IN1</sub> | Input Capacitance: A0-A9                                                                                                                           | 5    | pF   |
| C <sub>IN2</sub> | Input Capacitance: $\overline{\text{RAS}}$ , $\overline{\text{UCAS}}$ , $\overline{\text{LCAS}}$ , $\overline{\text{WE}}$ , $\overline{\text{OE}}$ | 7    | pF   |
| C <sub>IO</sub>  | Data Input/Output Capacitance: I/O0-I/O15                                                                                                          | 7    | pF   |

### Notes:

- Tested initially and after any design or process changes that may affect these parameters.
- Test conditions: T<sub>A</sub> = 25°C, f = 1 MHz,

**ELECTRICAL CHARACTERISTICS<sup>(1)</sup>** (Recommended Operation Conditions unless otherwise noted.)

| Symbol           | Parameter                                                                                   | Test Condition                                                                                               | Max. | Unit |
|------------------|---------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------|------|------|
| I <sub>DD1</sub> | Stand-by Current: TTL                                                                       | $\overline{RAS}, \overline{LCAS}, \overline{UCAS} \geq V_{IH}$                                               | 2    | mA   |
| I <sub>DD2</sub> | Stand-by Current: CMOS                                                                      | $\overline{RAS}, \overline{LCAS}, \overline{UCAS} \geq V_{DD} - 0.2V$                                        | 1    | mA   |
| I <sub>DD3</sub> | Operating Current:<br>Random Read/Write <sup>(2,3,4)</sup><br>Average Power Supply Current  | $\overline{RAS}, \overline{LCAS}, \overline{UCAS}$ ,<br>Address Cycling, $t_{RC} = t_{RC} \text{ (min.)}$    | 90   | mA   |
| I <sub>DD4</sub> | Operating Current:<br>Fast Page Mode <sup>(2,3,4)</sup><br>Average Power Supply Current     | $\overline{RAS} = V_{IL}, \overline{LCAS}, \overline{UCAS}$ ,<br>Cycling $t_{PC} = t_{PC} \text{ (min.)}$    | 30   | mA   |
| I <sub>DD5</sub> | Refresh Current:<br>$\overline{RAS}$ -Only <sup>(2,3)</sup><br>Average Power Supply Current | $\overline{RAS}$ Cycling, $\overline{LCAS}, \overline{UCAS} \geq V_{IH}$<br>$t_{RC} = t_{RC} \text{ (min.)}$ | 60   | mA   |
| I <sub>DD6</sub> | Refresh Current:<br>CBR <sup>(2,3,5)</sup><br>Average Power Supply Current                  | $\overline{RAS}, \overline{LCAS}, \overline{UCAS}$ Cycling<br>$t_{RC} = t_{RC} \text{ (min.)}$               | 60   | mA   |

**Notes:**

1. An initial pause of 200  $\mu s$  is required after power-up followed by eight  $\overline{RAS}$  refresh cycles ( $\overline{RAS}$ -Only or CBR) before proper device operation is assured. The eight  $\overline{RAS}$  cycles wake-up should be repeated any time the  $t_{REF}$  refresh requirement is exceeded.
2. Dependent on cycle rates.
3. Specified values are obtained with minimum cycle time and the output open.
4. Column-address is changed once each EDO page cycle.
5. Enables on-chip refresh and address counters.

**AC CHARACTERISTICS**<sup>(1,2,3,4,5,6)</sup>

(Recommended Operating Conditions unless otherwise noted.)

| Symbol            | Parameter                                                                                  | -50  |      | -60  |      | Units |
|-------------------|--------------------------------------------------------------------------------------------|------|------|------|------|-------|
|                   |                                                                                            | Min. | Max. | Min. | Max. |       |
| t <sub>RC</sub>   | Random READ or WRITE Cycle Time                                                            | 84   | —    | 104  | —    | ns    |
| t <sub>RAC</sub>  | Access Time from $\overline{\text{RAS}}$ <sup>(6, 7)</sup>                                 | —    | 50   | —    | 60   | ns    |
| t <sub>CAC</sub>  | Access Time from $\overline{\text{CAS}}$ <sup>(6, 8, 15)</sup>                             | —    | 13   | —    | 15   | ns    |
| t <sub>AA</sub>   | Access Time from Column-Address <sup>(6)</sup>                                             | —    | 25   | —    | 30   | ns    |
| t <sub>RAS</sub>  | $\overline{\text{RAS}}$ Pulse Width                                                        | 50   | 10K  | 60   | 10K  | ns    |
| t <sub>RP</sub>   | $\overline{\text{RAS}}$ Precharge Time                                                     | 30   | —    | 40   | —    | ns    |
| t <sub>CAS</sub>  | $\overline{\text{CAS}}$ Pulse Width <sup>(26)</sup>                                        | 8    | 10K  | 10   | 10K  | ns    |
| t <sub>CP</sub>   | $\overline{\text{CAS}}$ Precharge Time <sup>(9, 25)</sup>                                  | 9    | —    | 9    | —    | ns    |
| t <sub>CSH</sub>  | $\overline{\text{CAS}}$ Hold Time <sup>(21)</sup>                                          | 38   | —    | 40   | —    | ns    |
| t <sub>RCD</sub>  | $\overline{\text{RAS}}$ to $\overline{\text{CAS}}$ Delay Time <sup>(10, 20)</sup>          | 12   | 37   | 14   | 45   | ns    |
| t <sub>ASR</sub>  | Row-Address Setup Time                                                                     | 0    | —    | 0    | —    | ns    |
| t <sub>RAH</sub>  | Row-Address Hold Time                                                                      | 8    | —    | 10   | —    | ns    |
| t <sub>ASC</sub>  | Column-Address Setup Time <sup>(20)</sup>                                                  | 0    | —    | 0    | —    | ns    |
| t <sub>CAH</sub>  | Column-Address Hold Time <sup>(20)</sup>                                                   | 8    | —    | 10   | —    | ns    |
| t <sub>AR</sub>   | Column-Address Hold Time<br>(referenced to $\overline{\text{RAS}}$ )                       | 30   | —    | 40   | —    | ns    |
| t <sub>RAD</sub>  | $\overline{\text{RAS}}$ to Column-Address Delay Time <sup>(11)</sup>                       | 10   | 25   | 12   | 30   | ns    |
| t <sub>RAL</sub>  | Column-Address to $\overline{\text{RAS}}$ Lead Time                                        | 25   | —    | 30   | —    | ns    |
| t <sub>RPC</sub>  | $\overline{\text{RAS}}$ to $\overline{\text{CAS}}$ Precharge Time                          | 5    | —    | 5    | —    | ns    |
| t <sub>RSH</sub>  | $\overline{\text{RAS}}$ Hold Time <sup>(27)</sup>                                          | 8    | —    | 10   | —    | ns    |
| t <sub>RHCP</sub> | $\overline{\text{RAS}}$ Hold Time from $\overline{\text{CAS}}$ Precharge                   | 37   | —    | 37   | —    | ns    |
| t <sub>CLZ</sub>  | $\overline{\text{CAS}}$ to Output in Low-Z <sup>(15, 29)</sup>                             | 0    | —    | 0    | —    | ns    |
| t <sub>CRP</sub>  | $\overline{\text{CAS}}$ to $\overline{\text{RAS}}$ Precharge Time <sup>(21)</sup>          | 5    | —    | 5    | —    | ns    |
| t <sub>OD</sub>   | Output Disable Time <sup>(19, 28, 29)</sup>                                                | 3    | 15   | 3    | 15   | ns    |
| t <sub>OE</sub>   | Output Enable Time <sup>(15, 16)</sup>                                                     | —    | 13   | —    | 15   | ns    |
| t <sub>OED</sub>  | Output Enable Data Delay (Write)                                                           | 20   | —    | 20   | —    | ns    |
| t <sub>OEHC</sub> | $\overline{\text{OE}}$ HIGH Hold Time from $\overline{\text{CAS}}$ HIGH                    | 5    | —    | 5    | —    | ns    |
| t <sub>OEP</sub>  | $\overline{\text{OE}}$ HIGH Pulse Width                                                    | 10   | —    | 10   | —    | ns    |
| t <sub>OES</sub>  | $\overline{\text{OE}}$ LOW to $\overline{\text{CAS}}$ HIGH Setup Time                      | 5    | —    | 5    | —    | ns    |
| t <sub>RCS</sub>  | Read Command Setup Time <sup>(17, 20)</sup>                                                | 0    | —    | 0    | —    | ns    |
| t <sub>RRH</sub>  | Read Command Hold Time<br>(referenced to $\overline{\text{RAS}}$ ) <sup>(12)</sup>         | 0    | —    | 0    | —    | ns    |
| t <sub>RCH</sub>  | Read Command Hold Time<br>(referenced to $\overline{\text{CAS}}$ ) <sup>(12, 17, 21)</sup> | 0    | —    | 0    | —    | ns    |
| t <sub>WCH</sub>  | Write Command Hold Time <sup>(17, 27)</sup>                                                | 8    | —    | 10   | —    | ns    |

# IS41LV16105D

## AC CHARACTERISTICS (Continued)<sup>(1,2,3,4,5,6)</sup>

(Recommended Operating Conditions unless otherwise noted.)

| Symbol | Parameter                                                                                                         | -50  |      | -60  |      | Units |
|--------|-------------------------------------------------------------------------------------------------------------------|------|------|------|------|-------|
|        |                                                                                                                   | Min. | Max. | Min. | Max. |       |
| tWCR   | Write Command Hold Time<br>(referenced to $\overline{\text{RAS}}$ ) <sup>(17)</sup>                               | 40   | —    | 50   | —    | ns    |
| tWP    | Write Command Pulse Width <sup>(17)</sup>                                                                         | 8    | —    | 10   | —    | ns    |
| tWPZ   | $\overline{\text{WE}}$ Pulse Widths to Disable Outputs                                                            | 10   | —    | 10   | —    | ns    |
| trWL   | Write Command to $\overline{\text{RAS}}$ Lead Time <sup>(17)</sup>                                                | 13   | —    | 15   | —    | ns    |
| tcWL   | Write Command to $\overline{\text{CAS}}$ Lead Time <sup>(17, 21)</sup>                                            | 8    | —    | 10   | —    | ns    |
| twCS   | Write Command Setup Time <sup>(14, 17, 20)</sup>                                                                  | 0    | —    | 0    | —    | ns    |
| tdHR   | Data-in Hold Time (referenced to $\overline{\text{RAS}}$ )                                                        | 39   | —    | 39   | —    | ns    |
| tACH   | Column-Address Setup Time to $\overline{\text{CAS}}$<br>Precharge during WRITE Cycle                              | 15   | —    | 15   | —    | ns    |
| toEH   | $\overline{\text{OE}}$ Hold Time from $\overline{\text{WE}}$ during<br>READ-MODIFY-WRITE cycle <sup>(18)</sup>    | 8    | —    | 10   | —    | ns    |
| tDS    | Data-In Setup Time <sup>(15, 22)</sup>                                                                            | 0    | —    | 0    | —    | ns    |
| tdH    | Data-In Hold Time <sup>(15, 22)</sup>                                                                             | 8    | —    | 10   | —    | ns    |
| trWC   | READ-MODIFY-WRITE Cycle Time                                                                                      | 108  | —    | 133  | —    | ns    |
| trWD   | $\overline{\text{RAS}}$ to $\overline{\text{WE}}$ Delay Time during<br>READ-MODIFY-WRITE Cycle <sup>(14)</sup>    | 64   | —    | 77   | —    | ns    |
| tcWD   | $\overline{\text{CAS}}$ to $\overline{\text{WE}}$ Delay Time <sup>(14, 20)</sup>                                  | 26   | —    | 32   | —    | ns    |
| tAWD   | Column-Address to $\overline{\text{WE}}$ Delay Time <sup>(14)</sup>                                               | 39   | —    | 47   | —    | ns    |
| tpC    | Fast Page Mode READ or WRITE<br>Cycle Time <sup>(24)</sup>                                                        | 20   | —    | 25   | —    | ns    |
| trASP  | $\overline{\text{RAS}}$ Pulse Width                                                                               | 50   | 100K | 60   | 100K | ns    |
| tCPA   | Access Time from $\overline{\text{CAS}}$ Precharge <sup>(15)</sup>                                                | —    | 30   | —    | 35   | ns    |
| tPRWC  | READ-WRITE Cycle Time <sup>(24)</sup>                                                                             | 56   | —    | 68   | —    | ns    |
| tCOH   | Data Output Hold after $\overline{\text{CAS}}$ LOW                                                                | 5    | —    | 5    | —    | ns    |
| toFF   | Output Buffer Turn-Off Delay from<br>$\overline{\text{CAS}}$ or $\overline{\text{RAS}}$ <sup>(13,15,19, 29)</sup> | 1.6  | 12   | 1.6  | 15   | ns    |
| tWHZ   | Output Disable Delay from $\overline{\text{WE}}$                                                                  | 3    | 10   | 3    | 10   | ns    |
| tCLCH  | Last $\overline{\text{CAS}}$ going LOW to First $\overline{\text{CAS}}$<br>returning HIGH <sup>(23)</sup>         | 10   | —    | 10   | —    | ns    |
| tCSR   | $\overline{\text{CAS}}$ Setup Time (CBR REFRESH) <sup>(30, 20)</sup>                                              | 5    | —    | 5    | —    | ns    |
| tCHR   | $\overline{\text{CAS}}$ Hold Time (CBR REFRESH) <sup>(30, 21)</sup>                                               | 8    | —    | 10   | —    | ns    |
| tORD   | $\overline{\text{OE}}$ Setup Time prior to $\overline{\text{RAS}}$ during<br>HIDDEN REFRESH Cycle                 | 0    | —    | 0    | —    | ns    |
| tWRP   | $\overline{\text{WE}}$ Setup Time (CBR Refresh)                                                                   | 5    | —    | 5    | —    | ns    |
| tWRH   | $\overline{\text{WE}}$ Hold Time (CBR Refresh)                                                                    | 8    | —    | 10   | —    | ns    |
| tREF   | Auto Refresh Period (1,024 Cycles)                                                                                | —    | 16   | —    | 16   | ms    |
| tT     | Transition Time (Rise or Fall) <sup>(2, 3)</sup>                                                                  | 1    | 50   | 1    | 50   | ns    |

### Note:

The -60 timing parameters are shown for reference only. The -50 speed option supports 50ns and 60ns timing specifications.

## AC TEST CONDITIONS

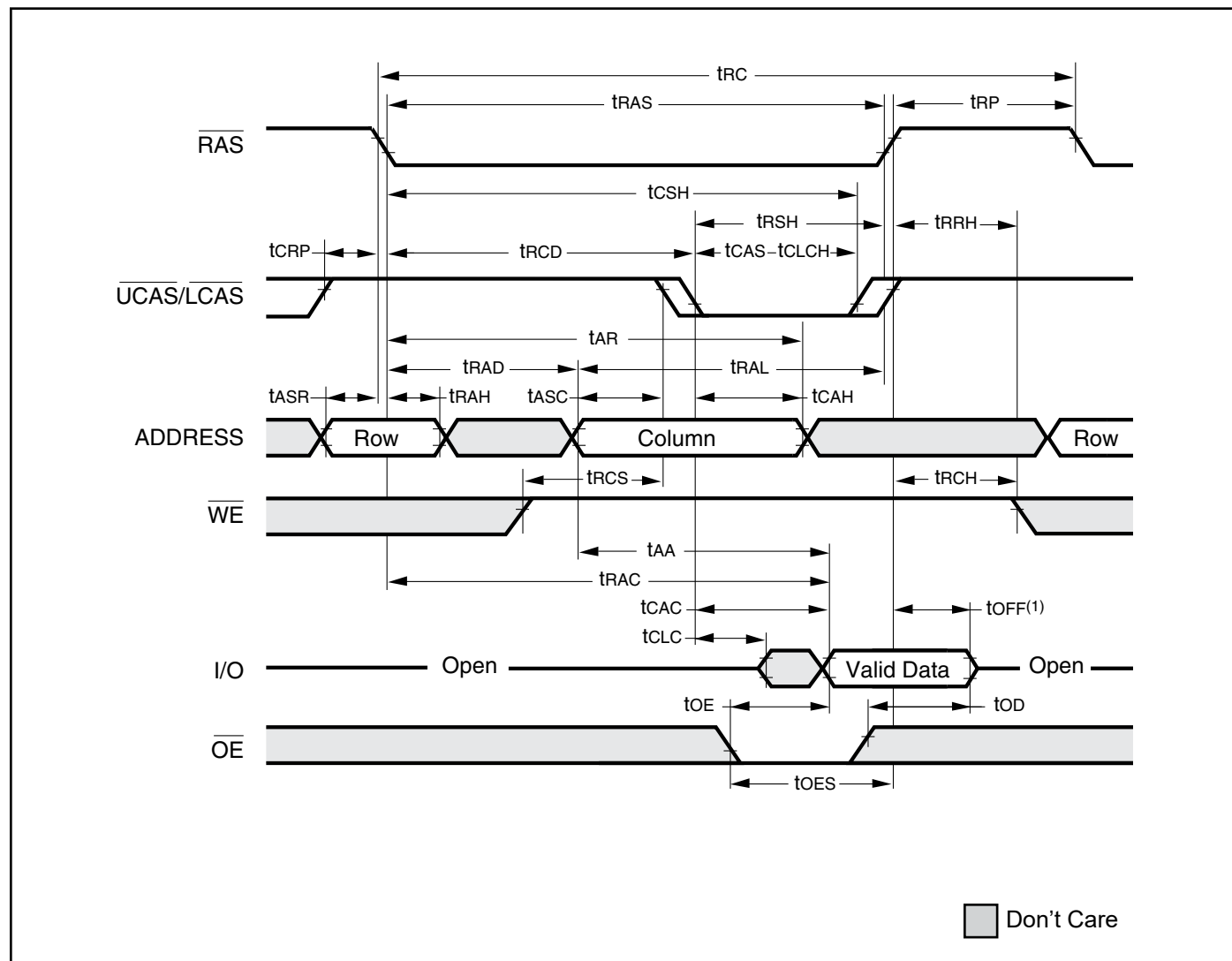
Output load: One TTL Load and 50 pF

Input timing reference levels:  $V_{IH} = 2.0V$ ,  $V_{IL} = 0.8V$

Output timing reference levels:  $V_{OH} = 2.4V$ ,  $V_{OL} = 0.4V$

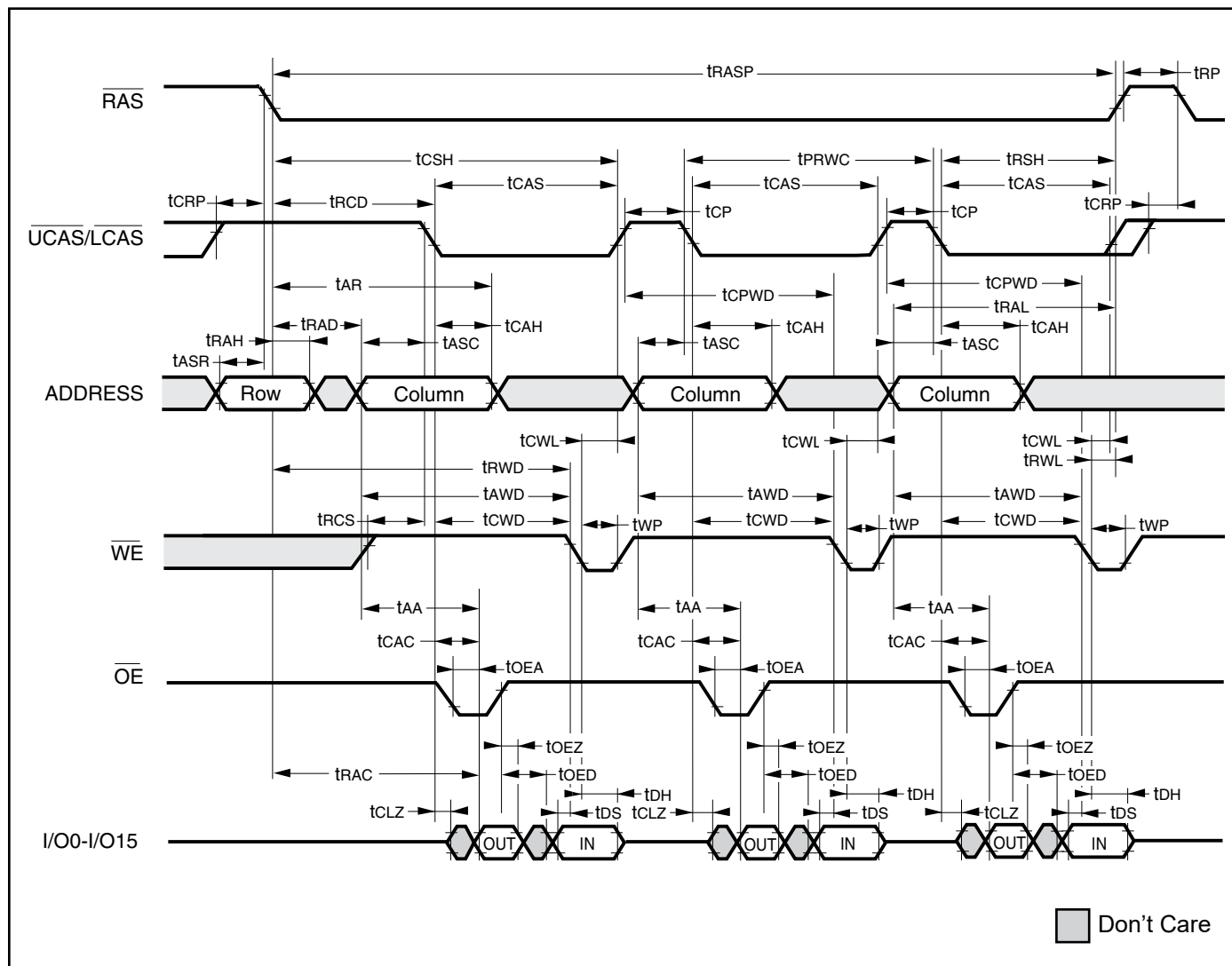
### Notes:

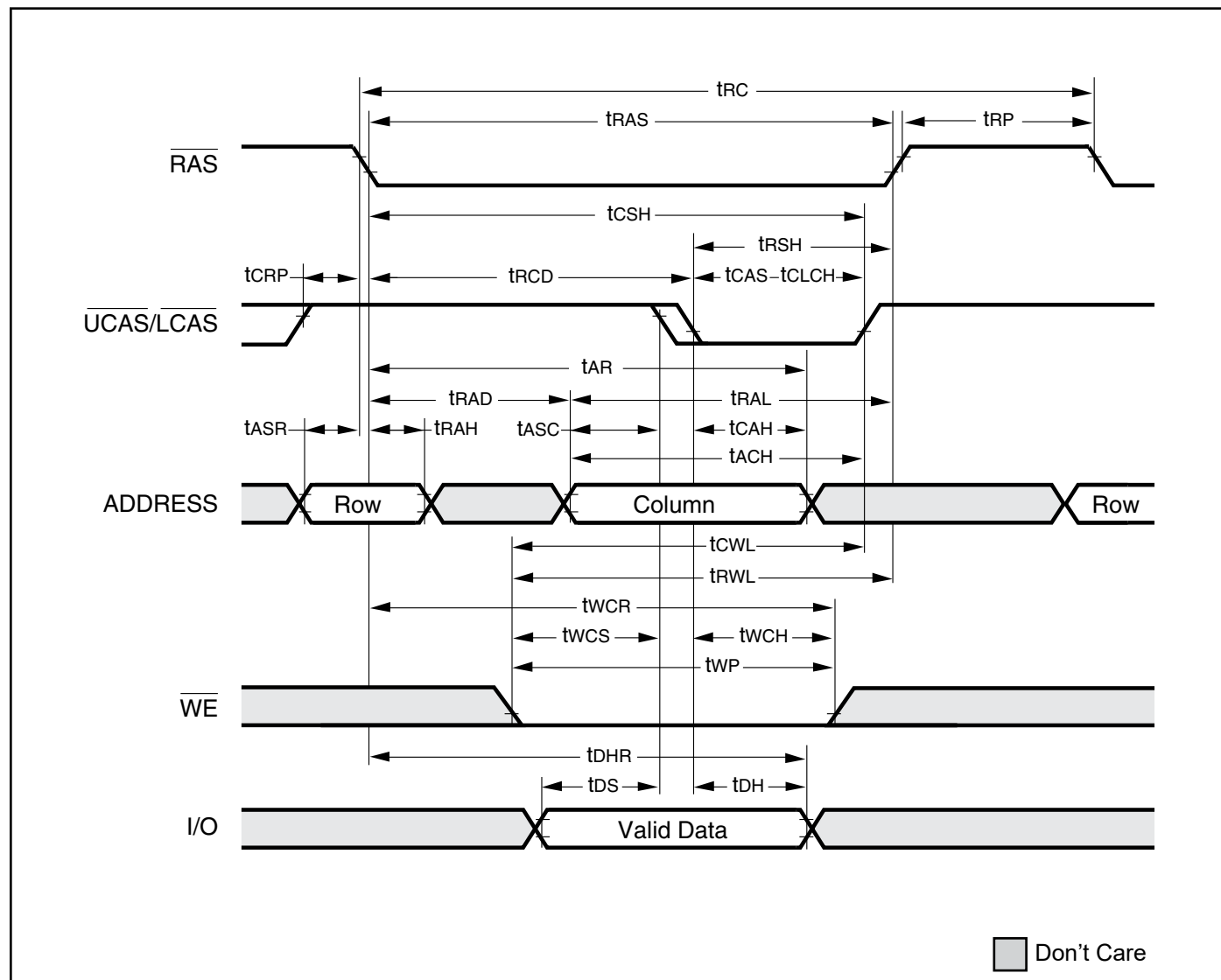
1. An initial pause of 200  $\mu s$  is required after power-up followed by eight  $\overline{RAS}$  refresh cycle ( $\overline{RAS}$ -Only or CBR) before proper device operation is assured. The eight  $\overline{RAS}$  cycles wake-up should be repeated any time the  $t_{REF}$  refresh requirement is exceeded.
2.  $V_{IH}$  (MIN) and  $V_{IL}$  (MAX) are reference levels for measuring timing of input signals. Transition times, are measured between  $V_{IH}$  and  $V_{IL}$  (or between  $V_{IL}$  and  $V_{IH}$ ) and assume to be 1 ns for all inputs.
3. In addition to meeting the transition rate specification, all input signals must transit between  $V_{IH}$  and  $V_{IL}$  (or between  $V_{IL}$  and  $V_{IH}$ ) in a monotonic manner.
4. If  $\overline{CAS}$  and  $\overline{RAS} = V_{IH}$ , data output is High-Z.
5. If  $\overline{CAS} = V_{IL}$ , data output may contain data from the last valid READ cycle.
6. Measured with a load equivalent to one TTL gate and 50 pF.
7. Assumes that  $tr_{CD} \leq tr_{CD} (MAX)$ . If  $tr_{CD}$  is greater than the maximum recommended value shown in this table,  $tr_{AC}$  will increase by the amount that  $tr_{CD}$  exceeds the value shown.
8. Assumes that  $tr_{CD} \leq tr_{CD} (MAX)$ .
9. If  $\overline{CAS}$  is LOW at the falling edge of  $\overline{RAS}$ , data out will be maintained from the previous cycle. To initiate a new cycle and clear the data output buffer,  $\overline{CAS}$  and  $\overline{RAS}$  must be pulsed for  $t_{CP}$ .
10. Operation with the  $tr_{CD} (MAX)$  limit ensures that  $tr_{AC} (MAX)$  can be met.  $tr_{CD} (MAX)$  is specified as a reference point only; if  $tr_{CD}$  is greater than the specified  $tr_{CD} (MAX)$  limit, access time is controlled exclusively by  $t_{CAC}$ .
11. Operation within the  $tr_{AD} (MAX)$  limit ensures that  $tr_{CD} (MAX)$  can be met.  $tr_{AD} (MAX)$  is specified as a reference point only; if  $tr_{AD}$  is greater than the specified  $tr_{AD} (MAX)$  limit, access time is controlled exclusively by  $t_{AA}$ .
12. Either  $tr_{CH}$  or  $tr_{RH}$  must be satisfied for a READ cycle.
13.  $t_{OFF} (MAX)$  defines the time at which the output achieves the open circuit condition; it is not a reference to  $V_{OH}$  or  $V_{OL}$ .
14.  $tw_{CS}$ ,  $tr_{WD}$ ,  $t_{AWD}$  and  $t_{CWD}$  are restrictive operating parameters in LATE WRITE and READ-MODIFY-WRITE cycle only. If  $tw_{CS} \geq tw_{CS} (MIN)$ , the cycle is an EARLY WRITE cycle and the data output will remain open circuit throughout the entire cycle. If  $tr_{WD} \geq tr_{WD} (MIN)$ ,  $t_{AWD} \geq t_{AWD} (MIN)$  and  $t_{CWD} \geq t_{CWD} (MIN)$ , the cycle is a READ-WRITE cycle and the data output will contain data read from the selected cell. If neither of the above conditions is met, the state of I/O (at access time and until  $\overline{CAS}$  and  $\overline{RAS}$  or  $\overline{OE}$  go back to  $V_{IH}$ ) is indeterminate.  $\overline{OE}$  held HIGH and  $\overline{WE}$  taken LOW after  $\overline{CAS}$  goes LOW result in a LATE WRITE ( $\overline{OE}$ -controlled) cycle.
15. Output parameter (I/O) is referenced to corresponding  $\overline{CAS}$  input, I/O0-I/O7 by  $\overline{LCAS}$  and I/O8-I/O15 by  $\overline{UCAS}$ .
16. During a READ cycle, if  $\overline{OE}$  is LOW then taken HIGH before  $\overline{CAS}$  goes HIGH, I/O goes open. If  $\overline{OE}$  is tied permanently LOW, a LATE WRITE or READ-MODIFY-WRITE is not possible.
17. Write command is defined as  $\overline{WE}$  going low.
18. LATE WRITE and READ-MODIFY-WRITE cycles must have both  $t_{OD}$  and  $t_{OE}$  met ( $\overline{OE}$  HIGH during WRITE cycle) in order to ensure that the output buffers will be open during the WRITE cycle. The I/Os will provide the previously written data if  $\overline{CAS}$  remains LOW and  $\overline{OE}$  is taken back to LOW after  $t_{OE}$  is met.
19. The I/Os are in open during READ cycles once  $t_{OD}$  or  $t_{OFF}$  occur.
20. The first  $\chi\overline{CAS}$  edge to transition LOW.
21. The last  $\chi\overline{CAS}$  edge to transition HIGH.
22. These parameters are referenced to  $\overline{CAS}$  leading edge in EARLY WRITE cycles and  $\overline{WE}$  leading edge in LATE WRITE or READ-MODIFY-WRITE cycles.
23. Last falling  $\chi\overline{CAS}$  edge to first rising  $\chi\overline{CAS}$  edge.
24. Last rising  $\chi\overline{CAS}$  edge to next cycle's last rising  $\chi\overline{CAS}$  edge.
25. Last rising  $\chi\overline{CAS}$  edge to first falling  $\chi\overline{CAS}$  edge.
26. Each  $\chi\overline{CAS}$  must meet minimum pulse width.
27. Last  $\chi\overline{CAS}$  to go LOW.
28. I/Os controlled, regardless  $\overline{UCAS}$  and  $\overline{LCAS}$ .
29. The 3 ns minimum is a parameter guaranteed by design.
30. Enables on-chip refresh and address counters.

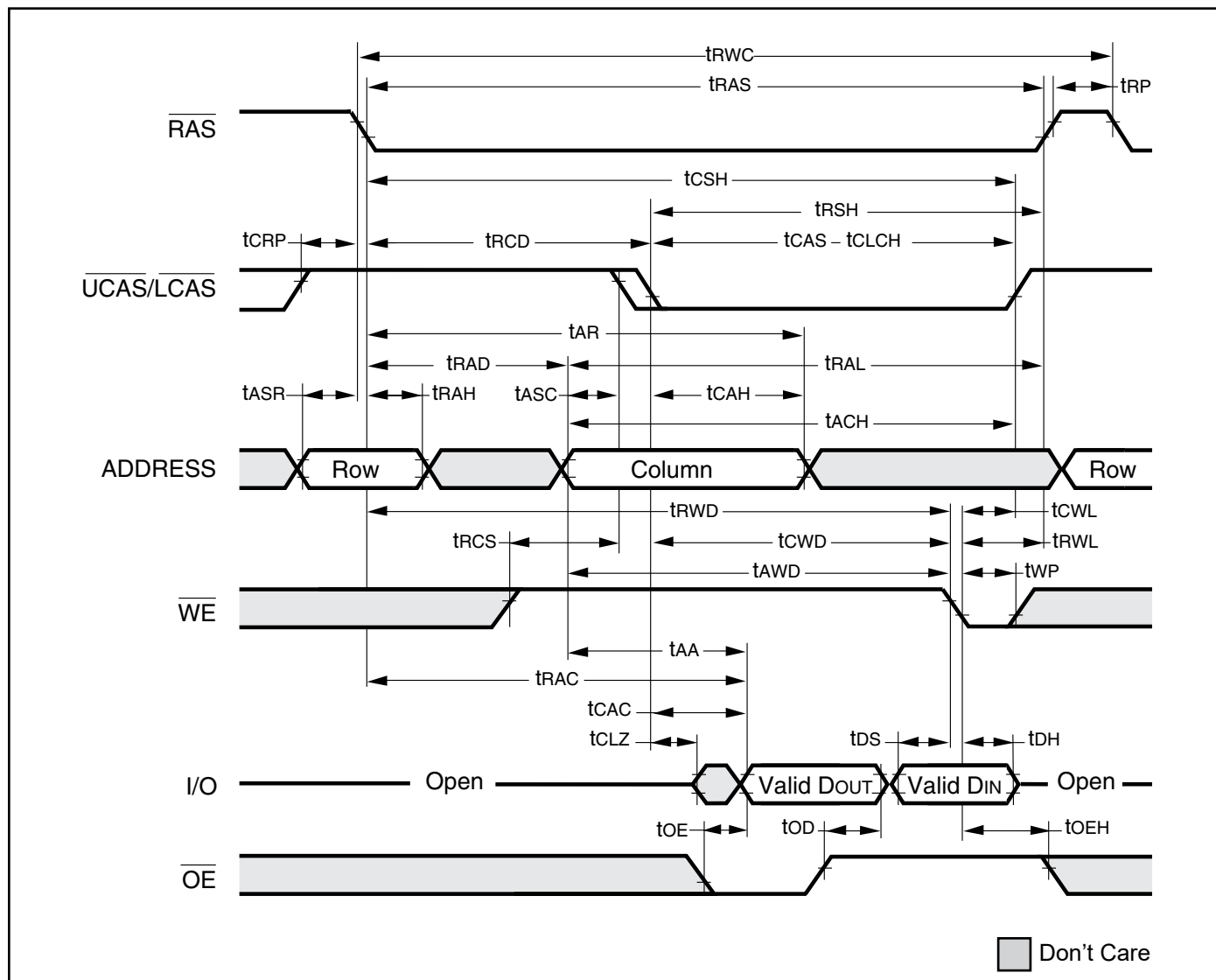
**FAST-PAGE-MODE READ CYCLE**

**Note:**

1.  $t_{OFF}$  is referenced from rising edge of  $\overline{RAS}$  or  $\overline{CAS}$ , whichever occurs last.

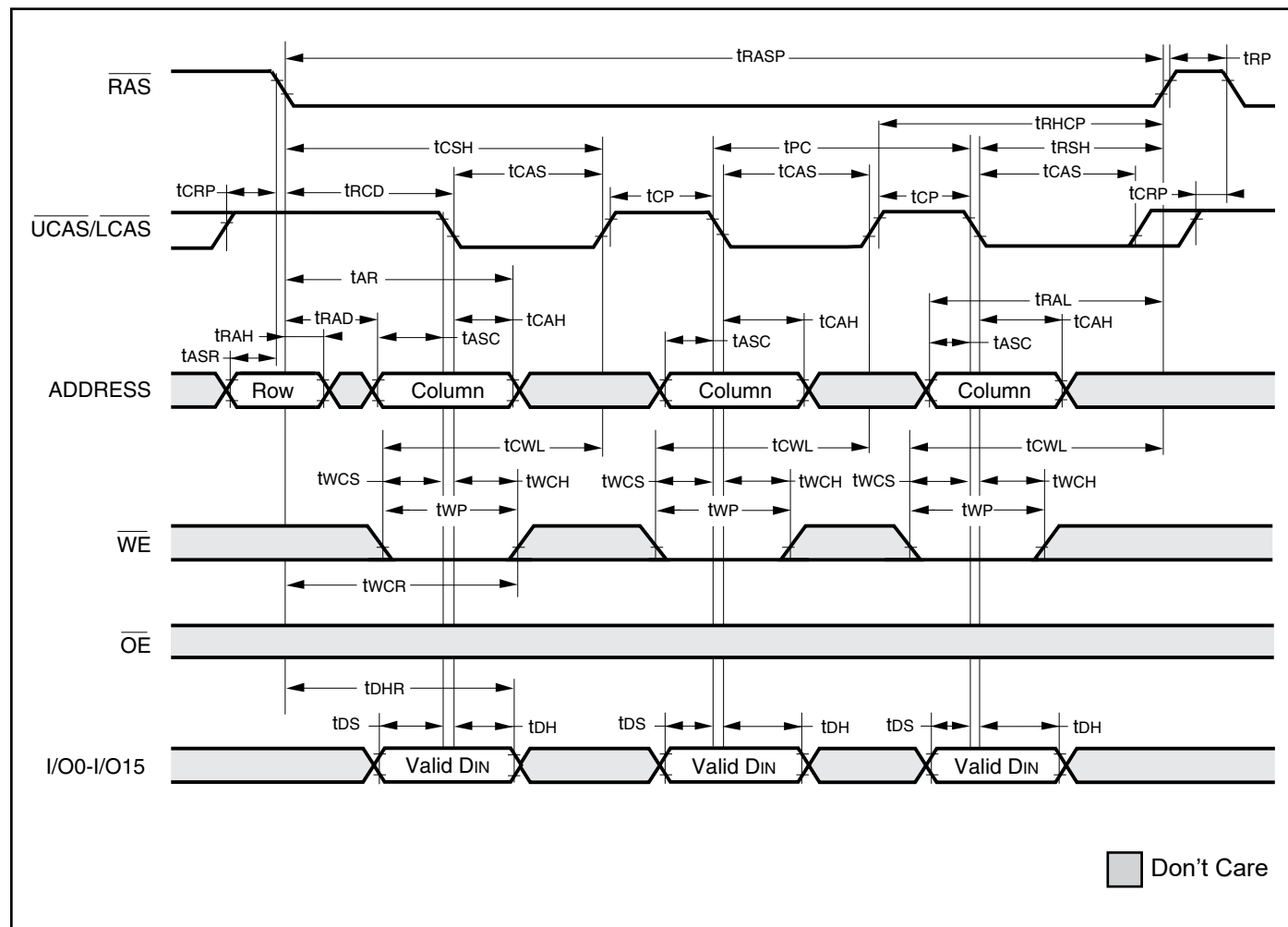
## FAST PAGE MODE READ-MODIFY-WRITE CYCLE



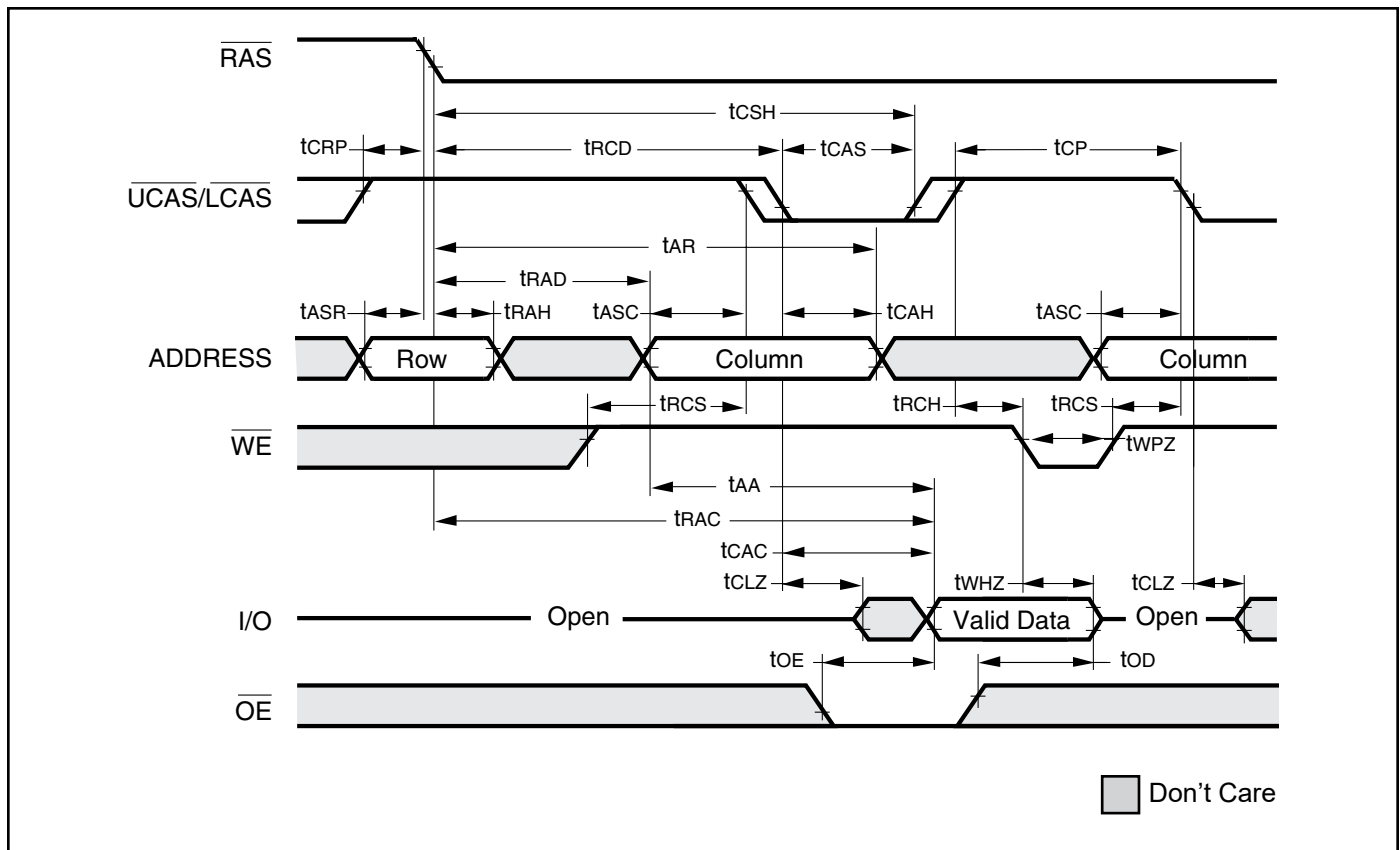
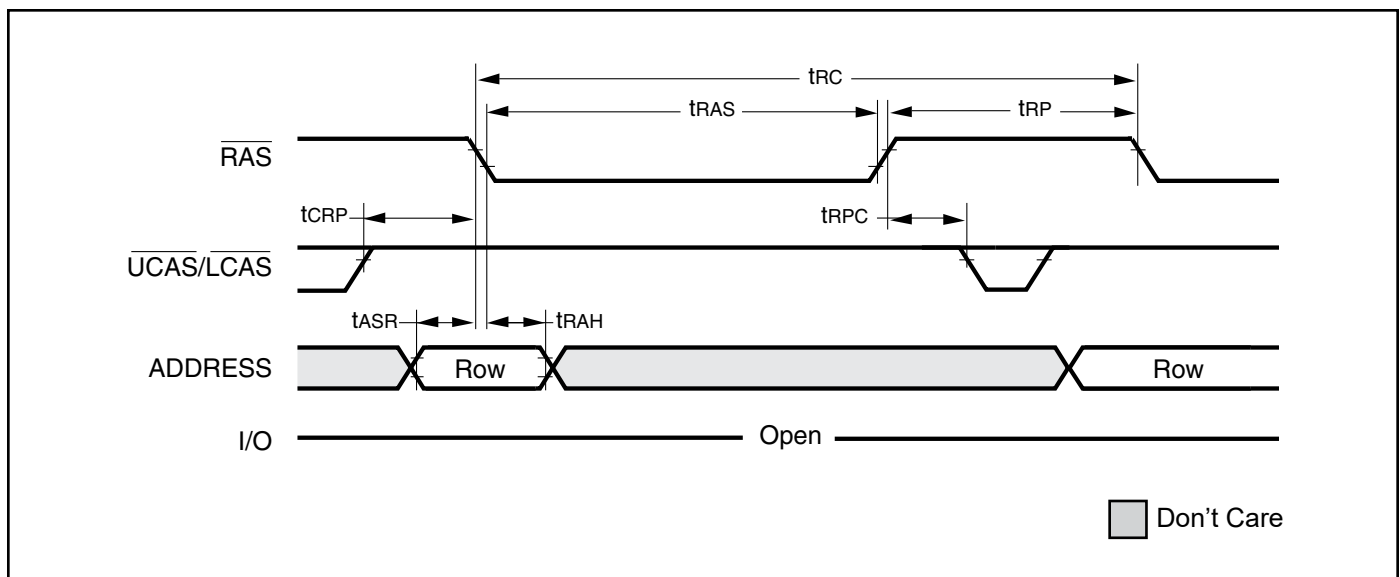
**FAST-PAGE-MODE EARLY WRITE CYCLE ( $\overline{OE}$  = DON'T CARE)**


**FAST-PAGE-MODE READ WRITE CYCLE (LATE WRITE and READ-MODIFY-WRITE Cycles)**


## FAST PAGE MODE EARLY WRITE CYCLE

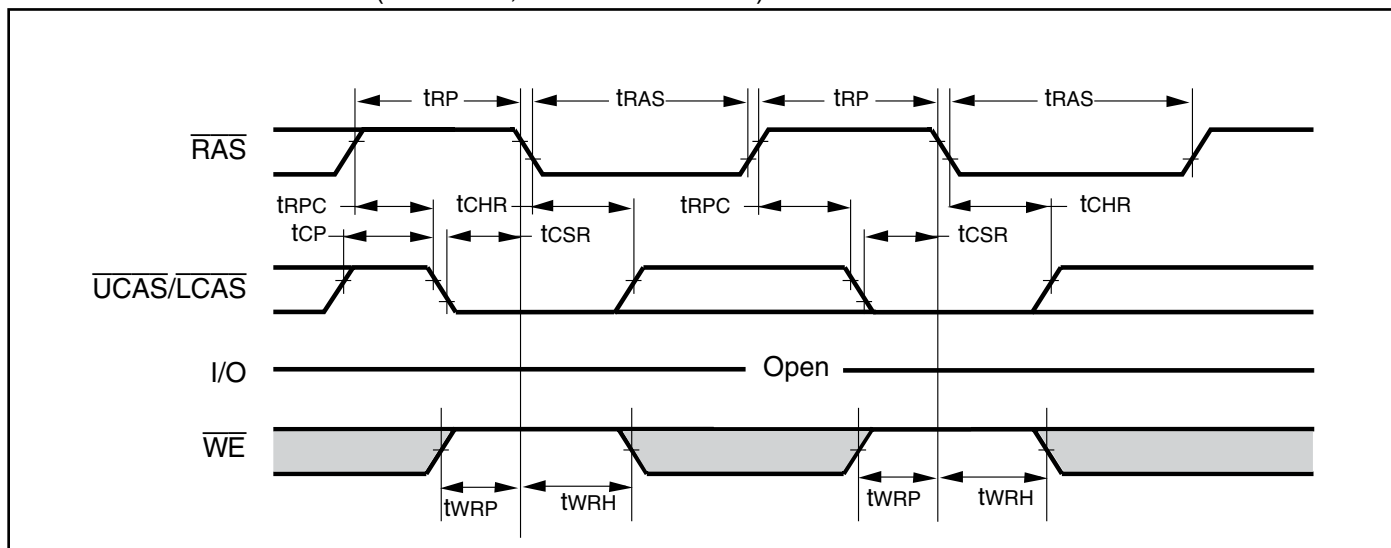


## AC WAVEFORMS

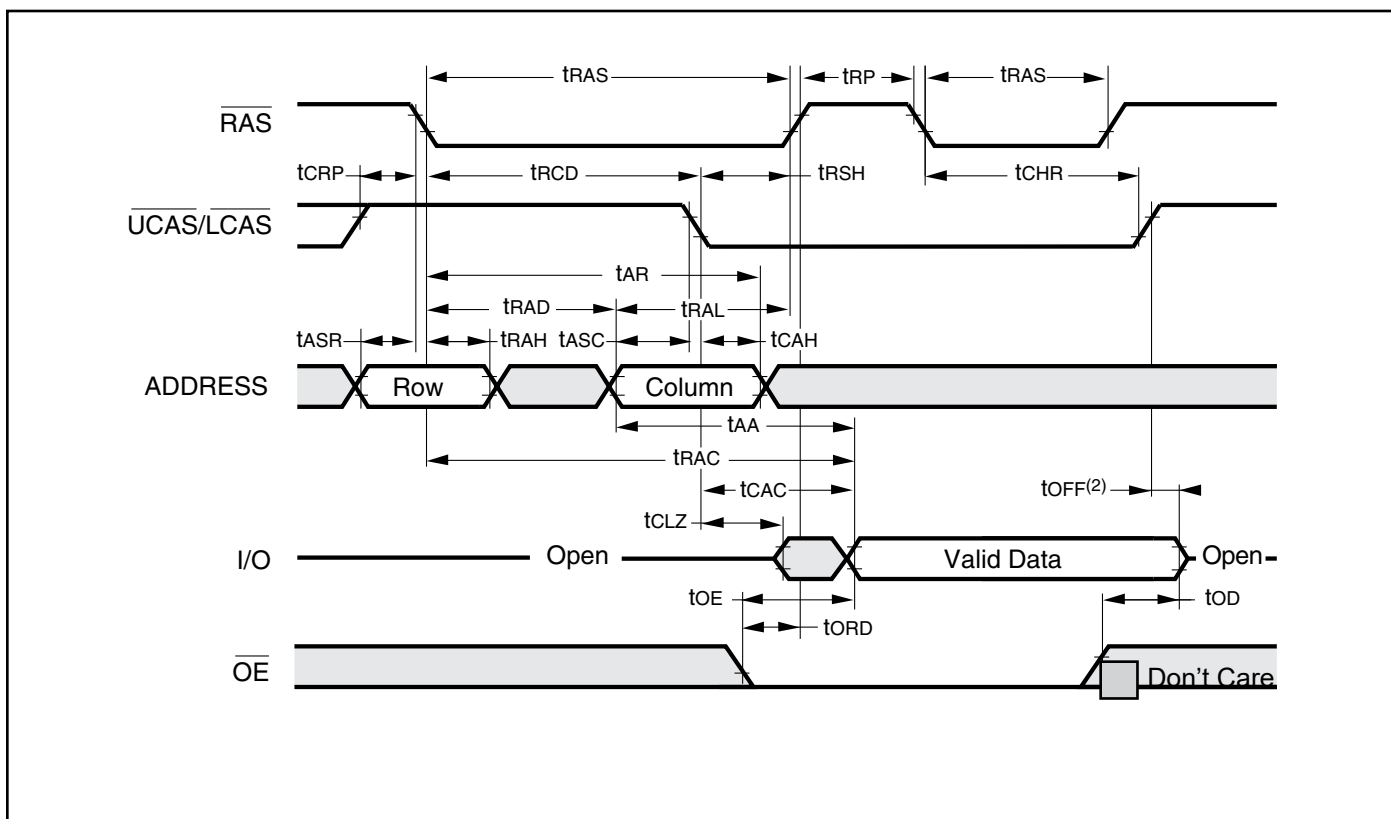
READ CYCLE (With  $\overline{WE}$ -Controlled Disable)RAS-ONLY REFRESH CYCLE ( $\overline{OE}$ ,  $\overline{WE}$  = DON'T CARE)

# IS41LV16105D

## CBR REFRESH CYCLE (Addresses; $\overline{OE}$ = DON'T CARE)



## HIDDEN REFRESH CYCLE<sup>(1)</sup> ( $\overline{WE}$ = HIGH; $\overline{OE}$ = LOW)



### Notes:

1. A Hidden Refresh may also be performed after a Write Cycle. In this case,  $\overline{WE}$  = LOW and  $\overline{OE}$  = HIGH.
2.  $t_{OFF}$  is referenced from rising edge of RAS or CAS, whichever occurs last.

## IS41LV16105D

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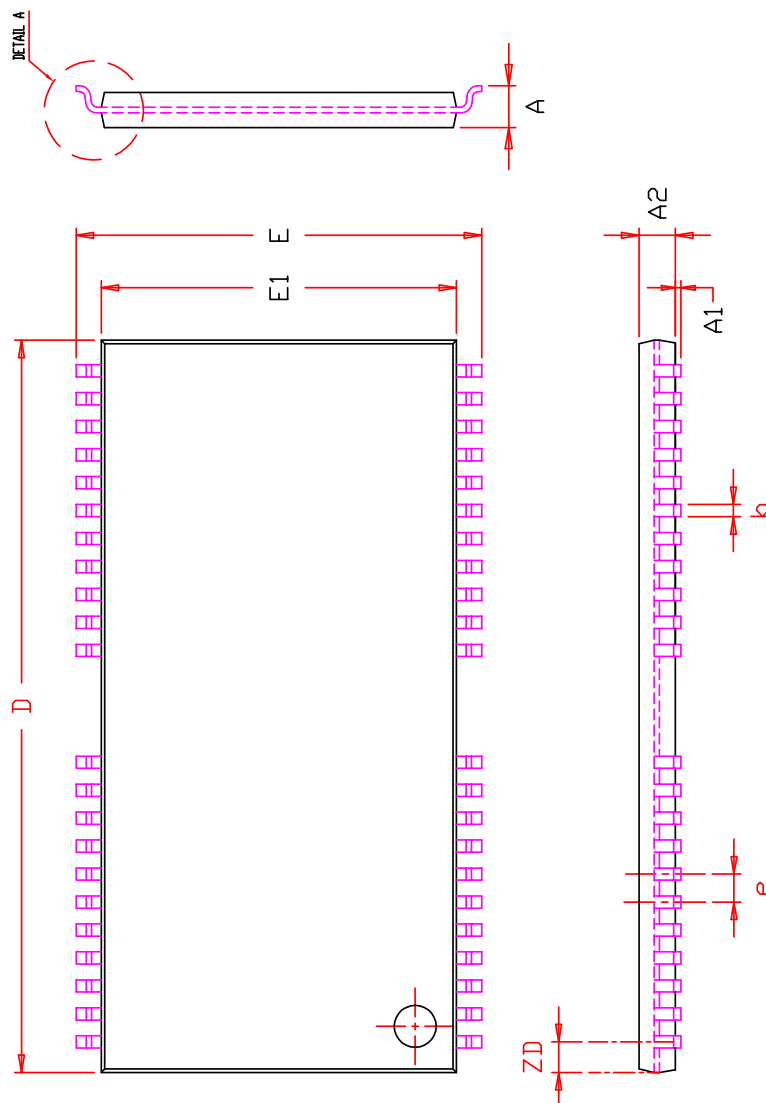
### ORDERING INFORMATION :

**Industrial Range: -40°C to +85°C**

| Speed (ns) | Order Part No.     | Package                           |
|------------|--------------------|-----------------------------------|
| 50         | IS41LV16105D-50TLI | 400-mil TSOP (Type II), Lead-free |

**Note:**

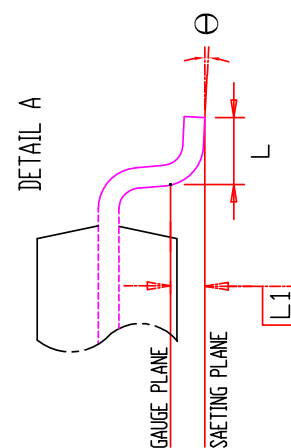
The -50 speed option supports 50ns and 60ns timing specifications.



| SYMBOL | DIMENSION IN MM |       |       | DIMENSION IN INCH |       |       |
|--------|-----------------|-------|-------|-------------------|-------|-------|
|        | MIN.            | NOM.  | MAX.  | MIN.              | NOM.  | MAX.  |
| A      | 1.00            |       | 1.20  | 0.039             |       | 0.047 |
| A1     | 0.05            |       | 0.15  | 0.002             |       | 0.006 |
| A2     | 0.95            | 1.00  | 1.05  | 0.037             | 0.039 | 0.041 |
| b      | 0.30            |       | 0.45  | 0.012             |       | 0.018 |
| D      | 20.82           | 20.95 | 21.08 | 0.820             | 0.825 | 0.830 |
| E      | 11.56           | 11.76 | 11.96 | 0.455             | 0.463 | 0.471 |
| E1     | 10.03           | 10.16 | 10.29 | 0.395             | 0.400 | 0.405 |
| e      | 0.80            | BSC.  | 0.031 | BSC.              |       |       |
| L      | 0.40            | 0.50  | 0.60  | 0.016             | 0.020 | 0.024 |
| L1     | 0.25            | BSC.  | 0.010 | BSC.              |       |       |
| ZD     | 0.875           | REF.  | 0.034 | REF.              |       |       |
| θ      | 0               |       | 8°    | 0                 |       | 8°    |

### NOTE :

1. CONTROLLING DIMENSION : MM
2. DIMENSION D AND E1 DO NOT INCLUDE MOLD PROTRUSION.
3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION/INTRUSION.



|                                                                                       |       |                                         |      |   |      |            |
|---------------------------------------------------------------------------------------|-------|-----------------------------------------|------|---|------|------------|
|  | TITLE | 44/50L 400mil TSOP-2<br>Package Outline | REV. | E | DATE | 03/19/2009 |
|---------------------------------------------------------------------------------------|-------|-----------------------------------------|------|---|------|------------|